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Fairchild Semiconductor FDB8832

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October 2011

FDB8832

N-Channel Logic Level PowerTrench® MOSFET 30V, 80A, 2.1m Ω

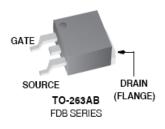
Features

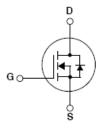
- Typ $r_{DS(on)}$ = 1.5m Ω at V_{GS} = 5V, I_D = 80A
- Typ $Q_{g(5)}$ = 100nC at V_{GS} = 5V
- Low Miller Charge
- Low Q_{rr} Body Diode
- UIS Capability (Single Pulse and Repetitive Pulse)
- RoHS Compliant



Applications

- Starter / Alternator Systems
- Electronic Power Steering Systems
- DC-DC Converters







MOSFET Maximum Ratings $T_C = 25^{\circ}C$ unless otherwise noted

Symbol	Parameter	Ratings	Units
V_{DSS}	Drain to Source Voltage	30	V
V_{GS}	Gate to Source Voltage	±20	V
	Drain Current Continuous (T _C < 165°C, V _{GS} = 10V)	80	
	Drain Current Continuous (T _C < 163°C, V _{GS} = 5V)	80	A
'D	Drain Current Continuous ($T_{amb} = 25^{\circ}C$, $V_{GS} = 10V$, with $R_{\theta JA} = 43^{\circ}C/W$)	34	_ ^
	Pulsed	See Figure 4	
E _{AS}	Single Pulse Avalanche Energy (Note 1)	1246	mJ
D	Power Dissipation	300	W
P_{D}	Derate above 25°C	2	W/°C
T_J , T_{STG}	Operating and Storage Temperature	-55 to +175	°C

Thermal Characteristics

$R_{\theta JC}$	Thermal Resistance, Junction to Case	0.5	°C/W	
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	(Note 2)	62	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient, lin ² copper pad area		43	°C/W

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDB8832	FDB8832	TO-263AB	330mm	24mm	800 units

Electrical Characteristics $T_J = 25^{\circ}C$ unless otherwise noted

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Cha	racteristics		•			
B _{VDSS}	Drain to Source Breakdown Voltage	$I_D = 250 \mu A, V_{GS} = 0 V$	30	-	-	V
1	Zero Gate Voltage Drain Current	V _{DS} = 24V	-	-	1	μА
DSS	Zero Gate Voltage Drain Current	$V_{GS} = 0V$ $T_J = 150$ °C	-	-	250	μΛ
I _{GSS}	Gate to Source Leakage Current	V _{GS} = ±20V	-	-	±100	nA

On Characteristics

$V_{GS(th)}$	Gate to Source Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	1.0	1.6	3.0	V
		I _D = 80A, V _{GS} = 10V	-	1.4	1.9	
		I _D = 80A, V _{GS} = 5V	-	1.5	2.1	
r _{DS(on)}	Drain to Source On Resistance	I _D = 80A, V _{GS} = 4.5V	-	1.6	2.2	mΩ
		I _D = 80A, V _{GS} = 10V T _J = 175°C	-	2.3	3.0	11122

Dynamic Characteristics

C _{iss}	Input Capacitance	-V _{DS} = 15V, V _{GS} = 0V, -f = 1MHz		-	11400	-	pF
Coss	Output Capacitance			-	2140	-	pF
C _{rss}	Reverse Transfer Capacitance			-	1260	-	pF
R_G	Gate Resistance	$V_{GS} = 0.5V, f = 1$	MHz	-	1.2	-	Ω
$Q_{g(TOT)}$	Total Gate Charge at 10V	$V_{GS} = 0$ to 10V			204	265	nC
$Q_{g(5)}$	Total Gate Charge at 5V	$V_{GS} = 0$ to 5V	.,		100	130	nC
$Q_{g(TH)}$	Threshold Gate Charge	$V_{GS} = 0$ to 1V	$V_{DD} = 15V$ $I_{D} = 80A$		10.9	14.2	nC
Q_{gs}	Gate to Source Gate Charge		$I_0 = 0.0A$		33	-	nC
Q _{gs2}	Gate Charge Threshold to Plateau		.g	-	22	-	nC
Q_{gd}	Gate to Drain "Miller" Charge			-	43	-	nC

FDB8832 N-Channel Logic Level PowerTrench® MOSFET

Electrical Characteristics $T_J = 25^{\circ}C$ unless otherwise noted

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Switchi	ng Characteristics					
$t_{(on)}$	Turn-On Time		-	-	155	ns
t _{d(on)}	Turn-On Delay Time		-	24	-	ns
t _r	Turn-On Rise Time	V _{DD} = 15V, I _D = 80A	-	73	-	ns
t _{d(off)}	Turn-Off Delay Time	V_{DD} = 15V, I_{D} = 80A V_{GS} = 5V, R_{GS} = 1.5 Ω	-	54	-	ns
t _f	Turn-Off Fall Time		-	38	-	ns
t _{off}	Turn-Off Time		-	-	149	ns

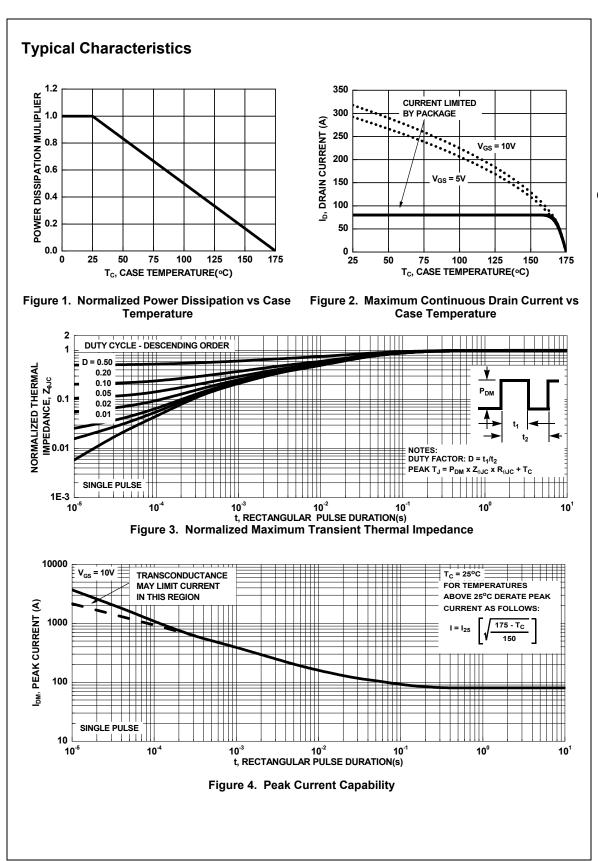
Drain-Source Diode Characteristics

V	Source to Drain Diode Voltage	I _{SD} = 75A	-	0.8	1.25	V
V_{SD}		I _{SD} = 40A	-	0.8	1.0	V
t _{rr}	Reverse Recovery Time	$I_F = 75A$, di/dt = 100A/ μ s	-	59	77	ns
Q_{rr}	Reverse Recovery Charge	$I_F = 75A$, di/dt = 100A/ μ s	-	67	87	nC

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Notes: 1: Starting $T_J = 25^{\circ}\text{C}$, L = 0.61mH, $I_{AS} = 64\text{A}$, $V_{DD} = 30\text{V}$, $V_{GS} = 10\text{V}$. 2: Pulse width = 100s.







Typical Characteristics

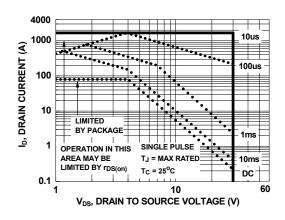
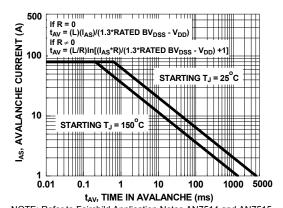


Figure 5. Forward Bias Safe Operating Area



NOTE: Refer to Fairchild Application Notes AN7514 and AN7515

Figure 6. Unclamped Inductive Switching

Capability

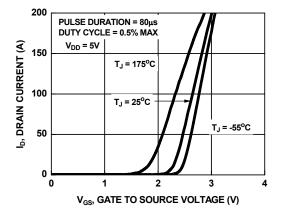


Figure 7. Transfer Characteristics

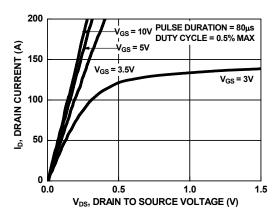


Figure 8. Saturation Characteristics

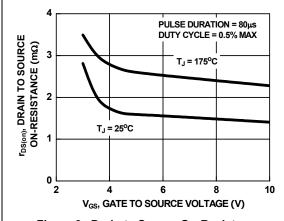


Figure 9. Drain to Source On-Resistance Variation vs Gate to Source Voltage

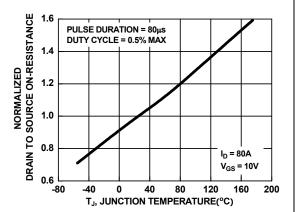
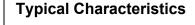


Figure 10. Normalized Drain to Source On Resistance vs Junction Temperature





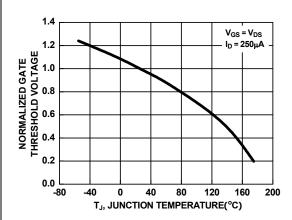


Figure 11. Normalized Gate Threshold Voltage vs Junction Temperature

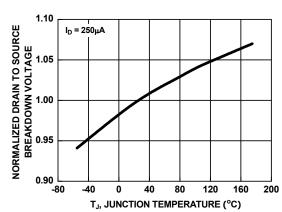


Figure 12. Normalized Drain to Source Breakdown Voltage vs Junction Temperature

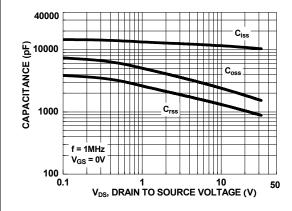


Figure 13. Capacitance vs Drain to Source Voltage

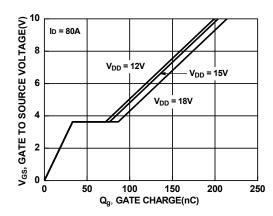


Figure 14. Gate Charge vs Gate to Source Voltage



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Datasheet of FDB8832 - MOSFET N-CH 30V 80A D2PAK

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